

## MPS2R10-606

## Monolithic Surface Mount (MMSM) Series-Shunt SP2T PIN Diode Reflective Switch

## New 1 GHz MMSM SP2T PIN Diode Switch Handles 100W CW Power

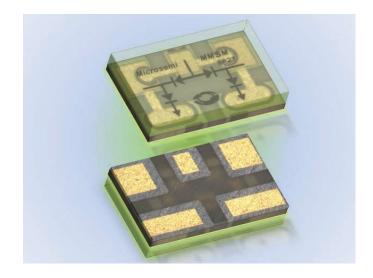
Microsemi is pleased to announce the MPS2R10-606, a new high power Monolithic Surface Mount (MMSM) series-shunt SP2T PIN diode reflective switch. Optimized for high power UHF and Transmit/Receive (T/R) switching applications, the switch provides frequency coverage from 0.1 GHz to 1 GHz with 0.2 dB insertion loss and 55 dB of isolation at mid-band. A simple analog control voltage allows this device to achieve 500 nS switching speeds while handling up to 100 W of continuous wave (CW) power.

Available in a compact (2.03 mm x 1.27 mm) highly-integrated

wafer-scale format, the MPS2R10-606 switch meets RoHS requirements per EU directive 2002/95/EC, and is fully compatible with pick and place and solder reflow manufacturing techniques.

For product sales or technical information contact <u>sales.</u> <u>support@microsemi.com</u>

Microsemi offers a complete line of RF and Microwave GaAs and silicon PIN diodes designed for low intermodulation switching and attenuation. Available products cover a wide variety of applications and range from ultra-low Cj, beam lead PIN diodes capable of switching up to 40 GHz, to high power PIN diodes designed to handle 60 dBm CW power.



Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information. Information provided in this document is proprietary to Microsemi, and Microsemi reserves the right to make any changes to the information in this document or to any products and services at any time without notice.



Microsemi Corporate Headquarters

One Enterprise, Aliso Viejo, CA 92656 USA Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 email: sales.support@microsemi.com www.microsemi.com

Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions, security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif., and has approximately 4,800 employees globally. Learn more at www.microsemi.com.